Radiation Report SN54SC8T595-SEP Single-Event Effects (SEE) Radiation Report



ABSTRACT

The purpose of this study is to characterize the single-event-effects (SEE) performance due to heavy-ion irradiation of the SN54SC8T595-SEP. SEE performance was verified at minimum (1.2V) and maximum (5.5V) operating conditions. Heavy-ions with an LET_{EFF} of 50MeV-cm²/ mg were used to irradiate three production devices with a fluence of 1 × 10⁷ ions / cm². The results demonstrate that the SN54SC8T595-SEP is SEL-free up to LET_{EFF} = 50MeV-cm² / mg as 125°C. SET performance at maximum operating voltage saw no excursions $\ge |1\%|$, as shown and discussed in this report. SET performance at minimum operating voltage saw one excursion $\ge |1\%|$, as shown and discussed in this report.

The SN54SC8T595-SEP Single-Event Effects (SEE) radiation report covers the SEE performance of all four devices listed below. The SN54SC8T595-SEP device covers all functional blocks and active die area of the other three devices, which is why the device was selected for single-event effect testing for this group of devices.

SN54SC8T595-SEP

- SN54SC8T164-SEP
- SN54SC8T374-SEP
- SN54SC8T574-SEP

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1 Overview

The SN54SC8T595-SEP is a radiation-tolerant, 1.2V to 5.5V 8-bit shift registers with 3-state output and logic level shifter. The input is designed with a lower threshold circuit to support up translation for lower voltage CMOS inputs (for example, 1.2V input to 1.8V output or 1.8V input to 3.3V output). In addition, the 5V tolerant input pins enable down translation (for example, 3.3V to 2.5V output).

For more information, see the SN54SC8T595-SEP product page.

Table 1-1. Overview Information

Description	Device Information			
TI Part Number	SN54SC8T595-SEP			
MLS Number	SN54SC8T595MPWTSEP			
Device Function	Radiation-tolerant, 1.2V to 5.5V, 8-Bit Shift Registers With 3-State Output And Logic Level Shifter			
Technology	LBC9			
Exposure Facility	Facility for Rare Isotope Beams (FRIB) at Michigan State University – FRIB Single Event Effects (FSEE) Facility			
Heavy Ion Fluence per Run	1 × 10 ⁷ ions / cm ²			
Irradiation Temperature	25°C (for SET testing) and 125°C (for SEL testing)			



2 Single-Event Effects (SEE)

The primary single-event effect (SEE) event of interest in the SN54SC8T595-SEP is the destructive single-event latch-up. From a risk or impact perspective, the occurrence of an SEL is potentially the most destructive SEE event and the biggest concern for space applications. In mixed technologies such as the Linear BiCMOS (LBC9) process used for SN54SC8T595-SEP, the CMOS circuitry introduces a potential SEL susceptibility. SEL can occur if excess current injection caused by the passage of an energetic ion is high enough to trigger the formation of a parasitic cross-coupled PNP and NPN bipolar structure (formed between the p-substrate and n-well and n+ and p+ contacts). The parasitic bipolar structure initiated by a single-event creates a high-conductance path (inducing a steady-state current that is typically orders-of-magnitude higher than the normal operating current) between power and ground that persists (is latched) until power is removed or until the device is destroyed by the high-current state. The process modifications applied for SEL-mitigation were sufficient, as the SN54SC8T595-SEP exhibited no SEL with heavy-ions up to an LET_{EFF} of 50MeV-cm² / mg at a fluence of 1 × 10⁷ ions / cm² and a chip temperature of 125°C.

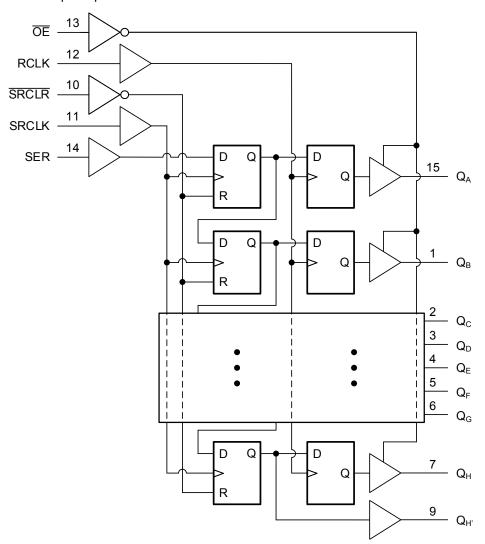
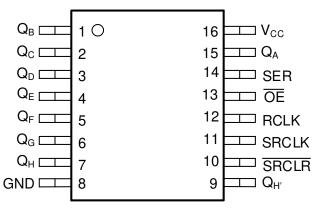


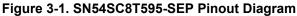
Figure 2-1. Functional Block Diagram of the SN54SC8T595-SEP



3 Test Device and Test Board Information

The SN54SC8T595-SEP is a packaged 16-pin, TSSOP plastic package shown in the pinout diagram in Figure 3-1. Figure 3-2 shows the device with the package cap decapped to reveal the die for heavy ion testing. Figure 3-3 shows the evaluation board used for radiation testing. Figure 3-4 shows the bias diagram used for Single-Event Latch-up (SEL) testing. Figure 3-5 and Figure 3-6 show the bias diagrams used for Single-Event Transient (SET) testing.





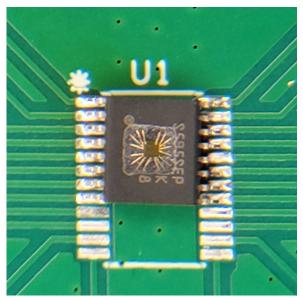
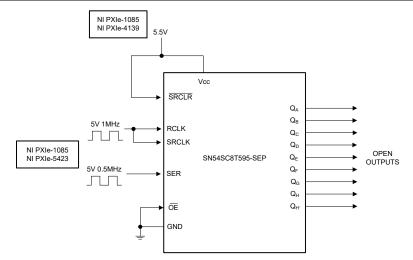


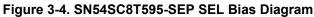
Figure 3-2. Photo of SN54SC8T595-SEP Package Decapped

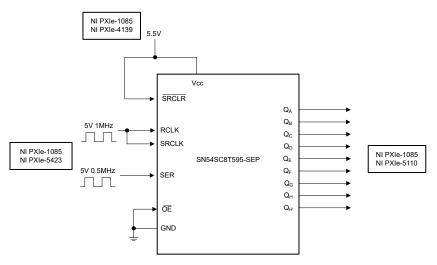


Figure 3-3. SN54SC8T595-SEP Evaluation Board (Top View)











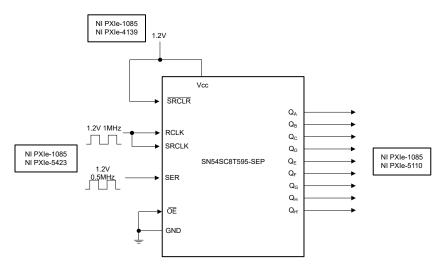


Figure 3-6. SN54SC8T595-SEP SET 1.2V Bias Diagram

4 Irradiation Facility and Setup

The heavy ion species used for the SEE studies on this product were provided and delivered by the Facility for Rare Isotope Beams (FRIB) at Michigan State University (FRIB Single Event Effects (FSEE) Facility's linear accelerator.) The FSEE Facility has a dedicated beamline built on the FRIB linac infrastructure with a user experimental station at the end of the FSEE beamline. Ion beams are delivered with high uniformity over a 1-inch diameter exposure area using a thin vacuum window. For this study, ion flux of 1 × 10⁵ ions / cm²-s was used to provide heavy ion fluence of 1×10^7 ions / cm² using ¹²⁹Xe ion at a linac energy of 25 MeV / μ . Ion beam uniformity for all tests was 96.77%.

Figure 4-1 shows one of the three SN54SC8T595-SEP test boards used for experiments at the MSU facility. The in-air gap between the device and the ion beam port window was maintained at 70mm for all runs.



the MSU Facility

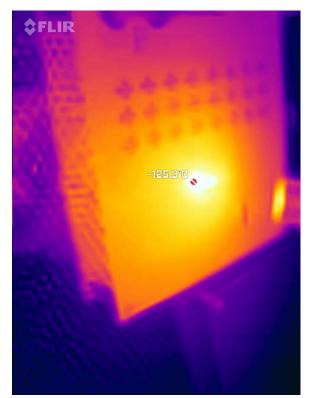


Figure 4-1. SN54SC8T595-SEP Evaluation Board at Figure 4-2. SN54SC8T595-SEP Thermal Image for SEL

5 Results

5.1 SEL Results

During SEL characterization, the device was heated using forced hot air, maintaining device temperature at 125°C. A FLIR (FLIR ONE Pro LT) thermal camera was used to validate die temperature to make sure the device was accurately heated (see Figure 4-2.) The species used for SEL testing was a Xenon (¹²⁹Xe) ion at 25MeV / μ with an angle-of-incidence of 0° for an LET_{EFF} of 50MeV-cm²/ mg. A fluence of approximately 1 × 10⁷ ions / cm² was used for each run.

The three devices were powered up and exposed to the heavy-ions using the maximum recommended supply voltage of 5.5V using a National Instruments[™] PXI Chassis PXIe-4139 and a 5V, 1MHz and 0.5MHz square wave input using a National Instruments[™] PXI Chassis PXIe-5423 function generator. The run duration to achieve this fluence was approximately 100 seconds. As listed in Table 5-1, no SEL events were observed during the nine runs, indicating that the SN54SC8T595-SEP is SEL-free. Figure 5-1, Figure 5-2, and Figure 5-3 show the plots of current versus time for runs one, thirteen, and twenty-four, respectively.

Run Number	Unit Number	Distance (mm)	Temperature (°C)	lon	Angle	Flux (ions × cm ² / mg)	Fluence (Number of ions)	LET _{EFF} (MeV × cm ² /mg)	Did an SEL Event Occur?
1	B3	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
2	B3	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
3	B3	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
11	B6	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
12	B6	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
13	B6	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
22	B7	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
23	B7	70	125	Xe	0°	1.00E+05	1.00E+07	50	No
24	B7	70	125	Xe	0°	1.00E+05	1.00E+07	50	No

Table 5-1. Summary of SN54SC8T595-SEP SEL Test Conditions and Results

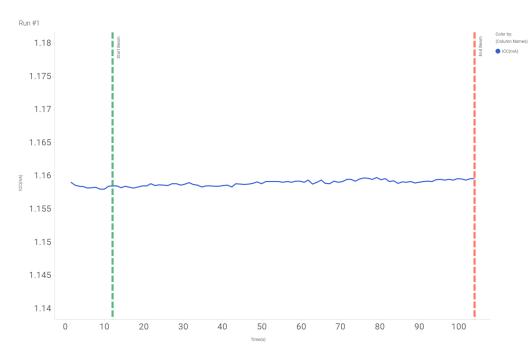


Figure 5-1. Current versus Time for Run 1 of the SN54SC8T595-SEP at T = 125°C



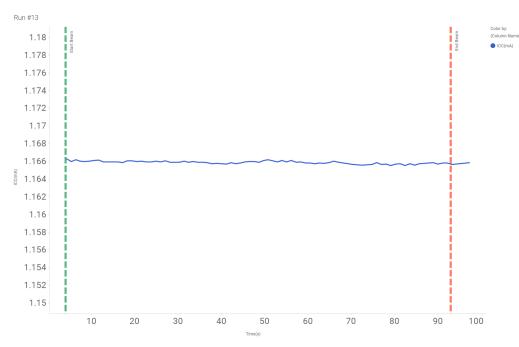
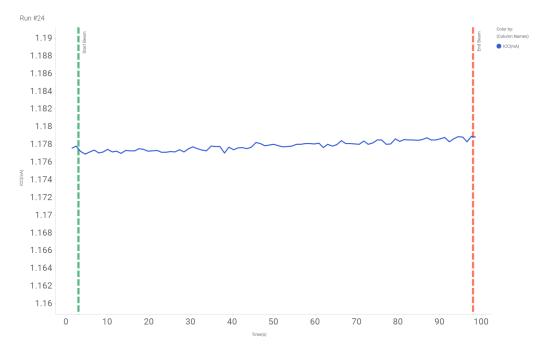


Figure 5-2. Current versus Time for Run 13 of the SN54SC8T595-SEP at T = 125°C





No SEL events were observed, indicating that the SN54SC8T595-SEP is SEL-immune at LET_{EFF} = 50MeV-cm² / mg and T = 125° C. Using the MFTF method shown in Single-Event Effects (SEE) Confidence Internal Calculations, the upper-bound cross-section (using a 95% confidence level) is calculated as:

$$\sigma_{\text{SEL}} \le 4.10 \times 10^{-8} \text{ cm}^2/\text{device for } \text{LET}_{\text{EFF}} = 50 \text{ MeV} \cdot \text{cm}^2/\text{mg and } \text{T} = 125^{\circ}\text{C}$$
(1)

5.2 Single-Event Transients (SET)

SETs are defined as heavy-ion-induced transient upsets on output pin Q _Aof the SN54SC8T595-SEP. SET testing was performed at room temperature (no external temperature control applied). The species used for the SET testing was ¹²⁹Xe for a LET_{EFF} = 50MeV × cm² / mg. Flux of approximately 10⁵ ions / cm² × s and a fluence of approximately 10⁷ ions / cm² were used for the SET runs.

Three units were tested across multiple input conditions to determine the worst-case setup for SETs. The unit was tested with V_{CC} of 1.2V, 3.3V and 5.5V and a rising edge window trigger of ±1% and ±5%. The 1.2V V_{CC} combination with ±1% trigger saw a single transient upset. The 3.3V and 5.5V combinations of V_{CC} and window triggers showed no transient upsets, as listed in Table 5-2

To capture SETs, one NI PXI-5110 scope card was used to continuously monitor the output voltage on pin Q_A . The NI scope was programmed to a sample rate of 100M samples per second (S/s) and recorded 10k samples, with a 20% pretrigger reference, in case of an event (trigger). Under heavy-ions, the SN54SC8T595-SEP only saw a transient at the harshest condition of 1.2V V_{CC} and ±1% (Run 21). Figure 5-4 shows the SET observed.

Run Number	Unit Number	Voltage Level	lon	LET _{EFF} (MeV × cm²/mg)	FLUX (ions × cm²/ mg)	Fluence (Number ions)	Window Trigger	SET Upsets
4	B3	5.5V	Xe	50	1.00E+05	1.00E+07	5%	0
5	B3	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0
6	B3	3.3V	Xe	50	1.00E+05	1.00E+07	5%	0
7	B3	3.3V	Xe	50	1.00E+05	1.00E+07	1%	0
8	B3	1.2V	Xe	50	1.00E+05	1.00E+07	5%	0
9	B3	1.2V	Xe	50	1.00E+05	1.00E+07	1%	0
14	B6	5.5V	Xe	50	1.00E+05	1.00E+07	5%	0
15	B6	5.5V	Xe	50	1.00E+05	1.00E+07	5%	0
16	B6	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0
17	B6	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0
18	B6	1.2V	Xe	50	1.00E+05	1.00E+07	1%	0
20	B6	1.2V	Xe	50	1.00E+05	1.00E+07	1%	0
21	B6	1.2V	Xe	50	1.00E+05	1.00E+07	1%	1
25	B7	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0
26	B7	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0
27	B7	5.5V	Xe	50	1.00E+05	1.00E+07	1%	0

Table 5-2. Summary of SN54SC8T595-SEP SET Test Condition and Results

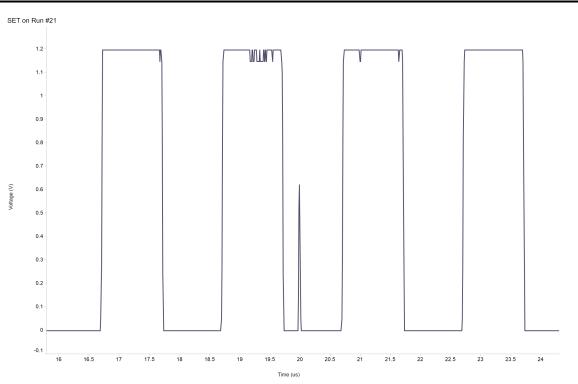


Figure 5-4. SET on Run 21 (1.2V V_{CC} and ±1%)

5.3 Event Rate Calculations

Event rates were calculated for LEO (ISS) and GEO environments by combining CREME96 orbital integral flux estimations and simplified SEE cross-sections according to methods shown in *Heavy Ion Orbital Environment Single-Event Effects Estimations*. A minimum shielding configuration of 100mils (2.54mm) of aluminum, and *worst-week* solar activity is assumed. (This is similar to a 99% upper bound for the environment.) Using the 95% upper-bounds for the SEL and the SET, the event rate calculations for the SEL are listed in Table 5-3. Note that this number is for reference since no SEL events were observed. The cross section for the SET is provided below in Equation 2 as 1 SET event was observed.

Orbit Type	Onset LET _{EFF} (MeV-cm ² / mg)	CREME96 Integral FLUX (per day / cm ²)	σSAT (cm²)	Event Rate (per day)	Event Rate (FIT)	MTBE (Years)
LEO (ISS)	50	3.80 × 10 ⁻⁴	4.10 × 10 ⁻⁸	1.56 × 10 ⁻¹¹	6.48 × 10 ⁻⁴	1.76 × 10 ⁸
GEO		1.23 × 10 ⁻³	4.10 × 10 -	5.04 × 10 ⁻¹¹	2.10 × 10 ⁻³	5.43 × 10 ⁷

 $\sigma_{SET} \le 3.48 \times 10^{-8} \text{ cm}^2$ for LET_{EFF} = 50 MeV·cm²/mg and 1 SET observed

(2)

MTBE is the mean-time-between-events in years at the given event rates. These rates clearly demonstrate the SEE robustness of the SN54SC8T595-SEP in two harshly conservative space environments. Customers using the SN54SC8T595-SEP must only use the above estimations as a rough guide and TI recommends performing event rate calculations based on specific mission orbital and shielding parameters to determine if the product satisfies the reliability requirements for the specific mission.



6 Summary

The purpose of this study was to characterize the effects of heavy-ion irradiation on the single-event latch-up (SEL) performance of the SN54SC8T595-SEP radiation-tolerant, 1.2V to 5.5V 8-bit shift registers with 3-state output and logic level shifter. SEE performance was verified at minimum (1.2V) and maximum (5.5V) operating conditions. Heavy-ions with an LET_{EFF} of 50MeV-cm²/ mg were used to irradiate three production devices with a fluence of 1×10^7 ions / cm². The results demonstrate that the SN54SC8T595-SEP is SEL-free up to LET_{EFF} = 50MeV-cm²/ mg as 125°C. SET performance for the maximum operating voltage saw no excursions $\ge |1\%|$. The minimum voltage saw 1 excursion at |1%|, as shown and discussed in this report. CREME96-based worst week event-rate calculations for LEO(ISS) and GEO orbits for the SEL and SET are presented for reference.

7 References

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- 8. A. J. Tylka, W. F. Dietrich, and P. R. Boberg, "Probability distributions of high-energy solar-heavy-ion fluxes from IMP-8: 1973-1996", *IEEE Trans. on Nucl. Sci., Vol. 44(6)*, Dec. 1997, pp. 2140-2149.

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